

SILTEL SG-TC2.0-A1 is an *ultrasoft* electrically insulating thermally conductive silicone gap filler material ideal for use in applications where thermal transfer over large gaps (large tolerances) or different stack ups must be achieved. Due to the specific formulation and ceramic particle filler, SG-TC2.0-A1 demonstrates reliable thermal conductivity through it's ultrasoft compliable features and overall elastomer design.

SG-TC2.0-A1 perfectly mates to irregular surfaces thus filling gaps and operates at low pressure offering low thermal resistance. The natural tackiness of the material allows for an easy and reliable pre-assembly.

- Ultrasoft and Compliant Pad Design
- Low Cost Gap Pad Filling Solution
- Excellent Chemical Resistance and Stability
- Operates at Low Pressure
- Shock Absorbing
- A1 (PSA Laminated 1 side)

Typical Applications

- SMD Packages
- Through-hole Vias
- RDRAMs Memory Modules
- Capacitors
- Interfaces with Large Gaps / Tolerances
- Electronics to Heat Pipe Assemblies

Standard Thickness Options

SG0.5-TC2.0-A1.....0.020" (0.50mm)
 SG1.0-TC2.0-A1.....0.039" (1.00mm)
 SG2.0-TC2.0-A1.....0.078" (2.00mm)
 SG3.0-TC2.0-A1.....0.118" (3.00mm)

Additional 0.059" (1.5mm), 0.158" (4mm) and 0.197" (5mm) thicknesses

SG-TC2.0-A1 General Properties

Thermal Conductivity.....2.0 W/m-K
 Color.....Light blue / gray
 Hardness.....15 (Shore 00)
 Dielectric Strength.....> 10 kV/mm
 Volume Resistivity..... 1.0×10^{10}
 Operating Temperature.....-40°C to 200°C

0.020" / 0.50mm Thermal Resistance

Thermal Impedance @ 10 PSI.....0.740 °C in² / Watt
 Thermal Impedance @ 30 PSI.....0.640 °C in² / Watt
 Thermal Impedance @ 60 PSI.....0.590 °C in² / Watt

0.039" / 1.00mm Thermal Resistance

Thermal Impedance @ 10 PSI.....1.320 °C in² / Watt
 Thermal Impedance @ 30 PSI.....1.160 °C in² / Watt
 Thermal Impedance @ 60 PSI.....1.030 °C in² / Watt

0.078" / 2.00mm Thermal Resistance

Thermal Impedance @ 10 PSI.....2.270 °C in² / Watt
 Thermal Impedance @ 30 PSI.....1.850 °C in² / Watt
 Thermal Impedance @ 60 PSI.....1.570 °C in² / Watt

0.118" / 3.00mm Thermal Resistance

Thermal Impedance @ 10 PSI.....2.960 °C in² / Watt
 Thermal Impedance @ 30 PSI.....2.330 °C in² / Watt
 Thermal Impedance @ 60 PSI.....1.900 °C in² / Watt

Standard SILTEL SG-TC2.0-A1 Cross Section

A1=adhesive layer one side

SG-TC2.0-A1 Pad
ceramic filled silicone pad only (no substrate)
A1 Adhesive Layer

Characteristic	SILTEL SG-TC2.0-A1
Base Material	Ceramic Filled Silicone
Substrate	NONE
Color	Light blue / gray
Available Formats	Sheets or Cut Pads
Standard Sheet Sizes	8.27" x 16.54" (210mm x 420mm)
Standard Adhesive	A1 PSA laminated 1 side
TIMTEL Cutting Capabilities	Plotter Cut for Gap Filler Pads
TIMTEL Die Cut Delivery Formats	Individuals or Multiples per Master Sheet
TIMTEL Die Cut Dimensional Tolerances	0.010"(0.25mm) to 0.020"(0.51mm) (depending on thickness)
Storage	Cool, dry location at or below 80F/ 27C
Shelf Life	2 years from date of manufacture

Thermal material evaluation is always critical when designing in a new material or developing a new product. Sheet samples of SILTEL are available for preliminary testing to determine the optimal SILTEL thickness as well as overall material construction best suited within the scope of your application requirements.

Want to test samples per your required die cut part? Our razor plotter sampling machine allows us to provide customers SILTEL material already cut to their required outline for testing. Plotter formed samples provide our customers the ability to test not only the SILTEL material itself, but their required outline as well without incurring the expense of production tooling.

Contact TIMTEL to request sample sheets or plotter formed samples for testing.

TIMTEL